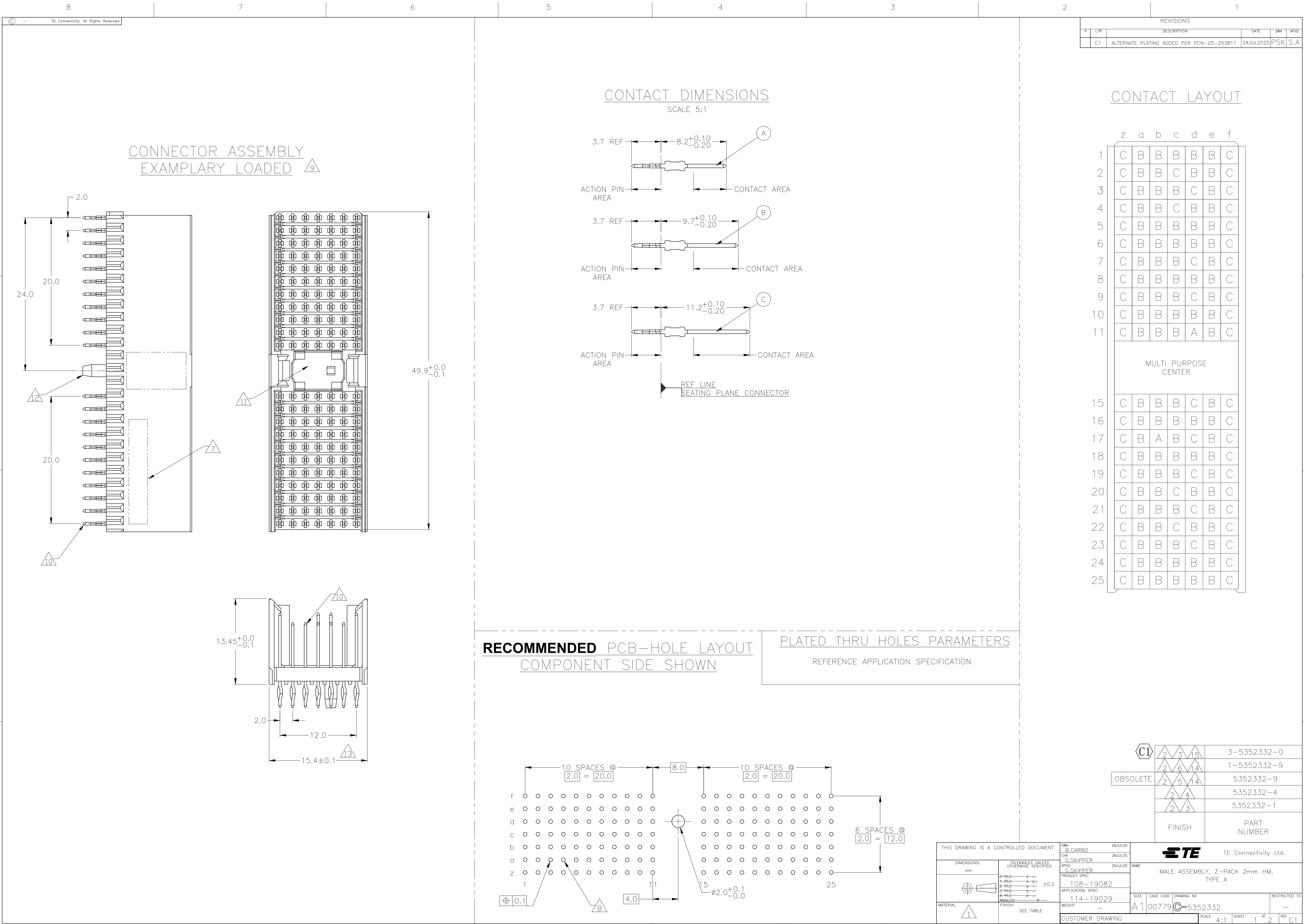
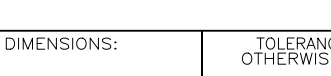




- 1 MATERIAL:
CONTACT: PHOSPHOR BRONZE.
HOUSING: GLASS-FILLED POLYESTER.
- 2 GENERAL PLATING SPECIFICATION: UNDERPLATING
(ENTIRE CONTACT): 1.27 μ m MIN NICKEL AND ACTION
PIN: 0.5 μ m MIN TIN.
FOR PLATING OF MATING SURFACES SEE APPLICABLE
SPECIFICATION REFERENCE FOR EACH DASH NUMBER.
- 3 CONFORMS TO ALL TESTING ACCORDING TO IEC 61076-4-101
PERFORMANCE LEVEL 2.
- 4 CONFORMS TO ALL TESTING ACCORDING TO IEC 61076-4-101
PERFORMANCE LEVEL 1.
- 5 CONNECTOR TESTED AND QUALIFIED AGAINST TELCORDIA GR-1217-CORE QUALITY LEVEL 3,
CENTRAL OFFICE APPLICATIONS.
- 6 CONNECTOR TESTED AND QUALIFIED AGAINST TELCORDIA GR-1217-CORE QUALITY LEVEL 3,
UNCONTROLLED ENVIRONMENT APPLICATIONS.
- 7 CONNECTOR MARKED WITH PART NUMBER AND DATE CODE.
ADDITIONAL CHARACTERS OR MARKINGS, AS WELL AS THE LOCATION OF THE MARKINGS,
MAY BE ADDED FOR TRACEABILITY BASED UPON MANUFACTURERS DISCRETION.
- 8 PLATED-THROUGH HOLES AT 2x2mm SQUARE GRID
PATTERN DEFINED BY CONTACT LAYOUT.
- 9 FOR ACTUAL PIN LOADING SEE "CONTACT LAYOUT".
- 10 FOR ACTUAL PIN DIMENSIONS SEE "CONTACT DIMENSIONS".
- 11 AREA RESERVED FOR KEYING PART (BASIC P/N 100525)
- 12 POLARIZATION FEATURE.
- 13 TO BE MEASURED AT BOTTOM OF SHROUD.
- 14 CONNECTOR LUBRICATED WITH BELCORE APPROVED LUBRICANT,
TECHNICAL REFERENCE: TR-NWT-001217 ISSUE 1, SEP 1992.
- 15 0.76 μ m MIN GOLD PLATING OR 0.08 μ m MIN GOLD OVER 0.68 μ m MIN PdNi PLATING ON MATING SURFACE. 

THIS DRAWING IS A CONTROLLED DOCUMENT.		DWA CARBO 26/JUL/05 CHK 26/JUL/05 APP'D SKIPPER 26/JUL/05 PWD SKIPPER		 TE Connectivity Ltd.	
DIMENSIONS: mm		TOLERANCES UNLESS OTHERWISE SPECIFIED: 0-PHIL ±0.2 1-PHIL ±0.1 2-PHIL ±0.1 3-PHIL ±0.1 4-PHIL ±0.1 FINISH ANGLE 1:1		NAME MALE ASSEMBLY, Z-PACK 2mm HM, TYPE A	
		PRODUCT SPEC 103-18082 APPLICATION SPEC 114-19029		SIZE A1	
MATERIAL SEE SHEET 1		WEIGHT —		GAGE CODE 00779	
SEE SHEET 1		CUSTOMER DRAWING		SCALE 4:1 SHEET 2 OF 2 REV C	